

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S45	137	((copper nickel solder) near10 plating) and (novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) and (polyacrylate polyacrylic polymethacrylic polyacrylate) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:16
S46	6276	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:18
S47	1773	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:19
S49	1290	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated plates)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:21
S48	1290	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated plate plates)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:21
S51	1016	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) with (acrylic methacrylic) adj (acid) and positiv\$10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:23
S50	229	(novolak or novalak or novolac or novolak or (phenol cresol) same (aldehyde formaldehyde)) same (acrylic methacrylic) adj (acid) and positiv\$10 and (plating plated)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/17 13:23
L1	279	electrolytic adj gold adj plating and (nickel solder copper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:43
L2	98	electrolytic adj gold adj plating and (nickel solder copper) and photoresist	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:44

EAST Search History

L4	18	electrolytic adj gold adj plating same (nickel solder copper) and photoresist and positiv\$	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:46
L3	60	electrolytic adj gold adj plating same (nickel solder copper) and photoresist	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/01/22 11:46